

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Lin et al.	Docket No.: TI-31518
Serial No: TBD	Examiner: TBD
Filed: 10/11/01	Art Unit: TBD
For: ELIMINATION OF OVERHANG IN LINER/BARRIER/SEED LAYERS USING POST-DEPOSITION SPUTTER ETCH	

PRELIMINARY AMENDMENT

October 11, 2001

Assistant Commissioner for Patents
Washington, DC 20231

Dear Sir:

Please amend the above referenced application as follows:

In the Specification:

Page 1, before line 1, insert --This application claims priority under 35 USC § 119(e)(1) of provisional application numbers 60/249,106 filed 11/16/00.--